SCLS140C - DECEMBER 1982 - REVISED DECEMBER 2002

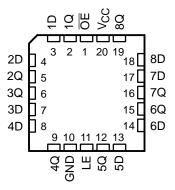
- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State True Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 13 ns

SN54HC373 . . . J OR W PACKAGE SN74HC373 . . . DB, DW, N, NS, OR PW PACKAGE (TOP VIEW)

ŌE [1	\bigcup_{20}] vcc
1Q [2	19] 8Q
1D [3	18] 8D
2D [4	17	7D
2Q [5	16] 7Q
3Q [6	15] 6Q
3D []7	14	[] 6D
4D [8	13] 5D
4Q [9	12] 5Q
GND [10	11	LE

- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Eight High-Current Latches in a Single Package
- Full Parallel Access for Loading

SN54HC373 . . . FK PACKAGE (TOP VIEW)



description/ordering information

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'HC373 devices are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs follow the data (D) inputs. When LE is taken low, the Q outputs are latched at the levels that were set up at the D inputs.

ORDERING INFORMATION

TA	PACKA	3E†	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	PDIP – N	PDIP – N Tube SN74		SN74HC373N	
	SOIC - DW	Tube	SN74HC373DW	HC373	
	301C = DW	Tape and reel	SN74HC373DWR	110373	
–40°C to 85°C	SOP - NS	Tape and reel	SN74HC373NSR	HC373	
	SSOP – DB	Tape and reel	SN74HC373DBR	HC373	
	TSSOP – PW	Tube	SN74HC373PW	HC373	
	1330F - FW	Tape and reel	SN74HC373PWR	псэтэ	
	CDIP – J	Tube	SNJ54HC373J	SNJ54HC373J	
–55°C to 125°C	25°C CFP – W Tube		SNJ54HC373W	SNJ54HC373W	
	LCCC – FK	Tube	SNJ54HC373FK	SNJ54HC373FK	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SCLS140C - DECEMBER 1982 - REVISED DECEMBER 2002

description/ordering information (continued)

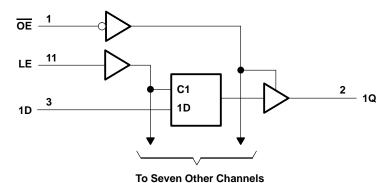
An output-enable (\overline{OE}) input places the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

OE does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are off.

FUNCTION TABLE (each latch)

	INPUTS		ОИТРИТ
OE	LE	D	Q
L	Н	Н	Н
L	Н	L	L
L	L	Χ	Q_0
Н	Χ	Χ	Z

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (se	ee Note 1)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VCO	c) (see Note 1)	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$		±35 mA
Continuous current through V _{CC} or GND		
Package thermal impedance, θ_{JA} (see Note 2):		
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
	PW package	83°C/W
Storage temperature range, T _{sto}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

SCLS140C - DECEMBER 1982 - REVISED DECEMBER 2002

recommended operating conditions (see Note 3)

			SN	154HC37	'3	SN74HC373		'3	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		2	5	6	2	5	6	V
		V _{CC} = 2 V	1.5			1.5			
ViH	High-level input voltage	$V_{CC} = 4.5 \text{ V}$	3.15			3.15			V
		V _{CC} = 6 V	4.2			4.2			
		V _{CC} = 2 V			0.5			0.5	
VIL	Low-level input voltage	V _{CC} = 4.5 V			1.35			1.35	V
		VCC = 6 V			1.8			1.8	
٧ _I	Input voltage		0		VCC	0		VCC	V
٧o	Output voltage		0		VCC	0		VCC	V
		V _{CC} = 2 V			1000			1000	
Δt/Δν	Input transition rise/fall time	$V_{CC} = 4.5 V$			500			500	ns
		VCC = 6 V			400			400	
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CO	ONDITIONS	Vaa	Т	A = 25°C	;	SN54H	IC373	SN74H	C373	UNIT		
PARAMETER	1251 CC	CNDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII		
			2 V	1.9	1.998		1.9		1.9				
		I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4				
Voн	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V		
		$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84				
		$I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2		5.34				
		I _{OL} = 20 μA	2 V		0.002	0.1		0.1		0.1			
			4.5 V		0.001	0.1		0.1		0.1			
VOL	$V_I = V_{IH}$ or V_{IL}		6 V		0.001	0.1		0.1		0.1	V		
				$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
		$I_{OL} = 7.8 \text{ mA}$	6 V		0.15	0.26		0.4		0.33			
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA		
loz	$V_O = V_{CC}$ or 0		6 V		±0.01	±0.5		±10		±5	μΑ		
Icc	$V_I = V_{CC}$ or 0,	IO = 0	6 V			8		160		80	μΑ		
Ci			2 V to 6 V		3	10		10		10	pF		

SN54HC373, SN74HC373 **OCTAL TRANSPARENT D-TYPE LATCHES** WITH 3-STATE OUTPUTS SCLS140C - DECEMBER 1982 - REVISED DECEMBER 2002

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		Vaa	T _A = 25°C		SN54HC373		SN74HC373		UNIT
		VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
	2 V	80		120		100			
t _W	t _W Pulse duration, LE high	4.5 V	16		24		20		ns
		6 V	14		20		17		
		2 V	50		75		63		
t _{su}	Setup time, data before LE↓	4.5 V	10		15		13		ns
		6 V	9		13		11		
		2 V	20		26		24	, in the second	
t _h	Hold time, data after LE↓	4.5 V	10		13		12		ns
		6 V	10		13		12		

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	V	T,	√ = 25°C	;	SN54H	C373	SN74H	SN74HC373	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		58	150		225		190	
	D	Q	4.5 V		15	30		45		38	
			6 V		13	26		38		32	
^t pd			2 V		73	175		265		220	ns
	LE	Any Q	4.5 V		18	35		53		44	
			6 V		15	30		45		38	
			2 V		65	150		225		190	
t _{en}	ŌĒ	Any Q	4.5 V		17	30		45		38	ns
			6 V		14	26		38		32	
			2 V		50	150		225		190	
t _{dis}	ŌĒ	Any Q	4.5 V		15	30		45		38	ns
			6 V		13	26		38		32	
			2 V		28	60		90		75	
t _t		Any Q	4.5 V		8	12		18		15	ns
			6 V		6	10		15		13	

SN54HC373, SN74HC373 OCTAL TRANSPARENT D-TYPE LATCHES WITH 3-STATE OUTPUTS

SCLS140C - DECEMBER 1982 - REVISED DECEMBER 2002

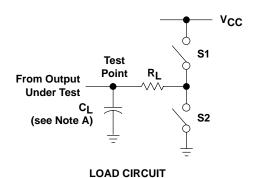
switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

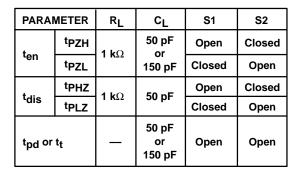
PARAMETER	FROM	то	Vaa	T,	Վ = 25° C	;	SN54H	IC373	SN74H	C373	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
D		2 V		82	200		300		250			
	D	Q	4.5 V		22	40		60		50		
			6 V		19	34		51		43		
^t pd			2 V		100	225		335		285	ns	
	LE	Any Q	4.5 V		24	45		67		57		
			6 V		20	38		57		48		
			2 V		90	200		300		250		
t _{en}	ŌĒ	Any Q	4.5 V		23	40		60		50	ns	
			6 V		19	34		51		43		
			2 V		45	210		315		265		
t _t		Any Q	Any Q	4.5 V		17	42		63		53	ns
			6 V		13	36		53		45		

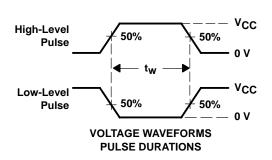
operating characteristics, $T_A = 25^{\circ}C$

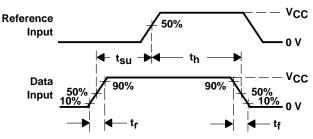
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per latch	No load	100	pF

PARAMETER MEASUREMENT INFORMATION

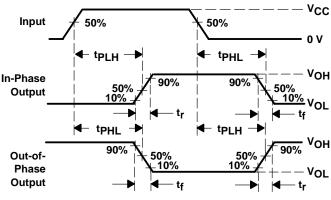


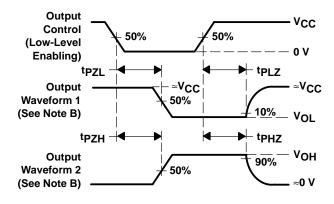






VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES





VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns, t_f = 6 ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



14 LEADS SHOWN



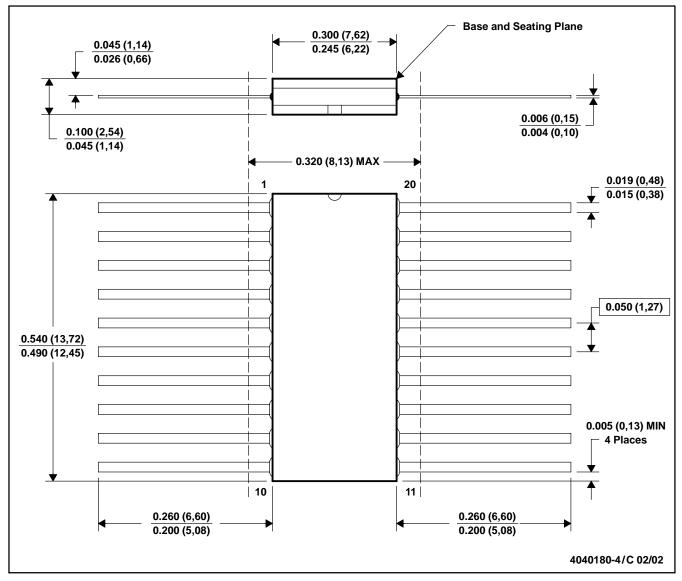
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK

1



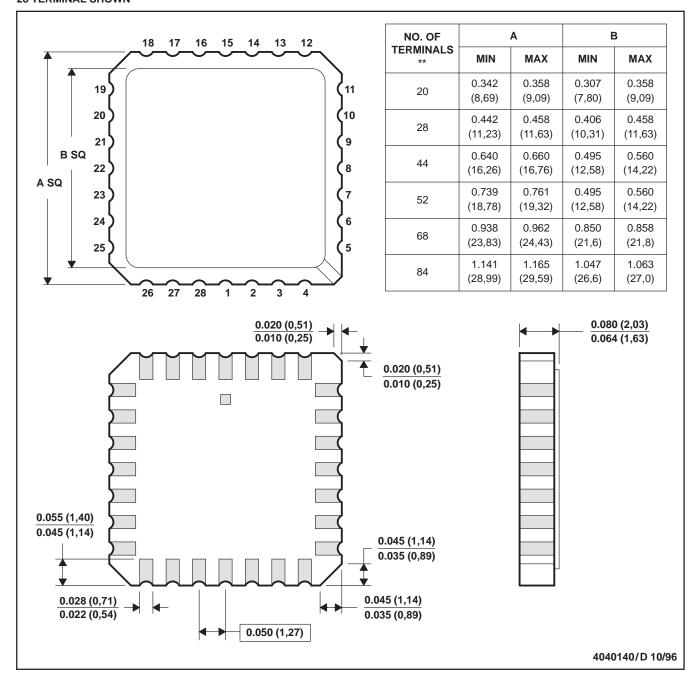
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



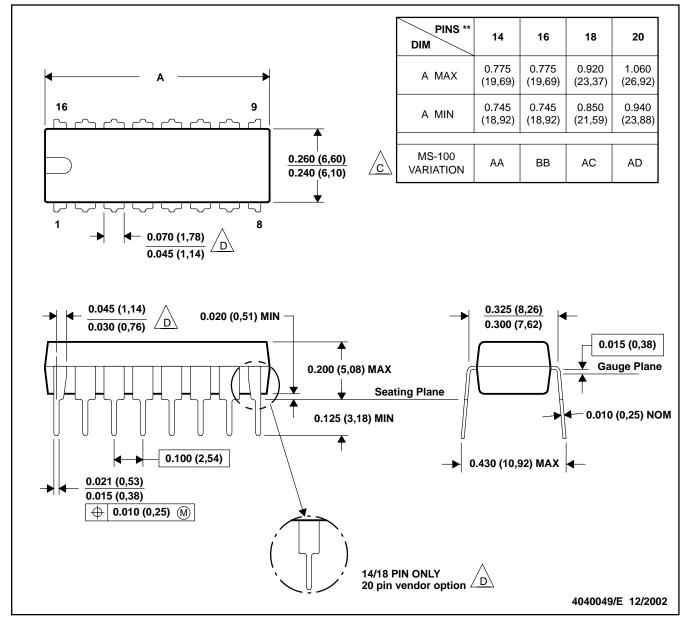
- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004



N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

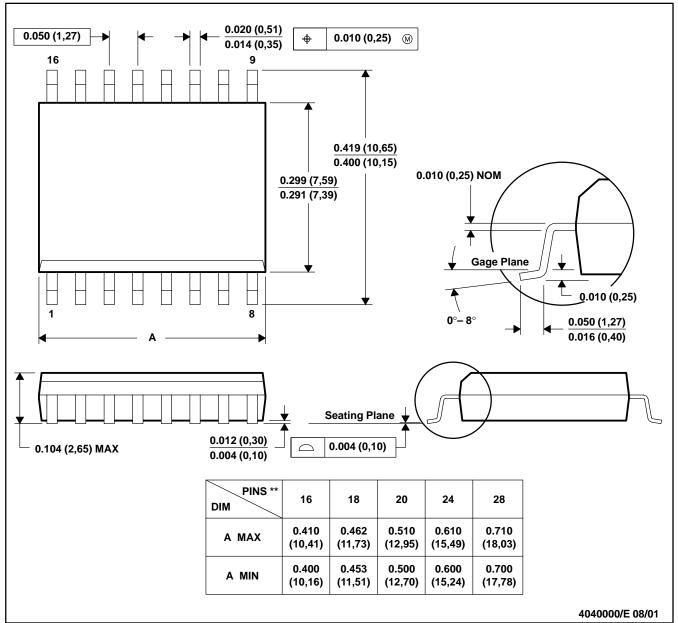
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

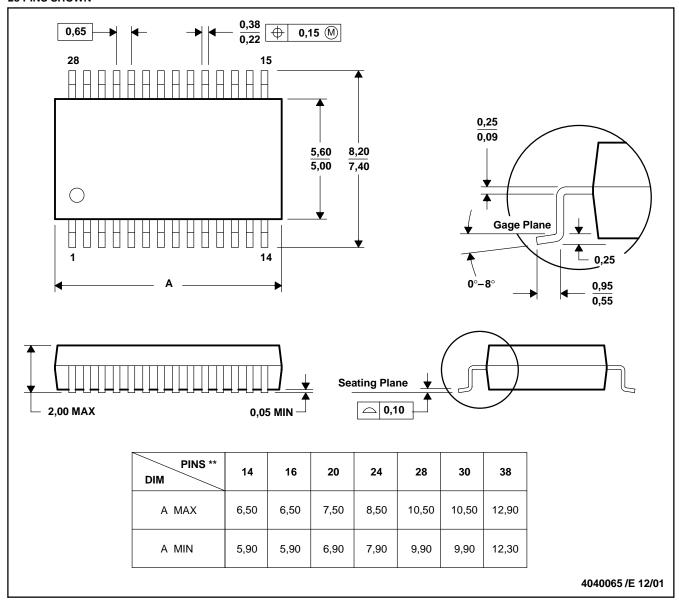
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

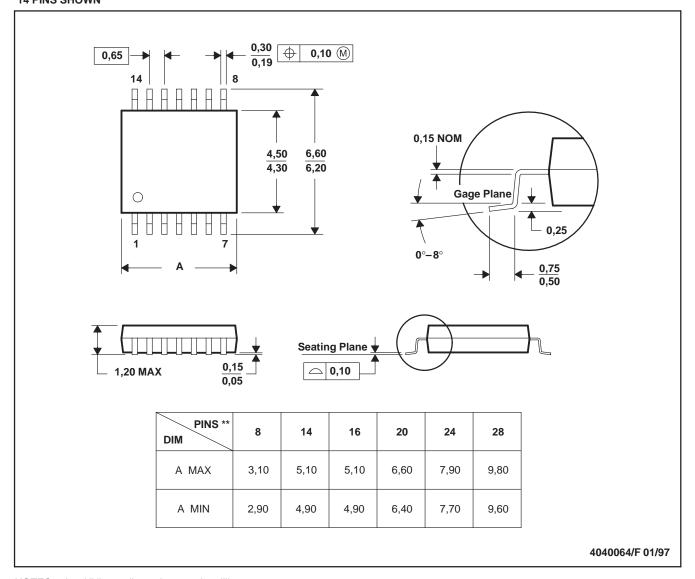
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated